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10/810,040	03/26/2004	Donald A. Ice	15436.446.1	8454

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EXAMINER

BEVERIDGE, RACHEL E

ART UNIT	PAPER NUMBER
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1725

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PAPER

Please find below and/or attached an Office communication concerning this application or proceeding.

The time period for reply, if any, is set in the attached communication.

Office Action Summary	Application No. 10/810,040	Applicant(s) ICE, DONALD A.	
	Examiner Rachel E. Beveridge	Art Unit 1725	

-- The MAILING DATE of this communication appears on the cover sheet with the correspondence address --

Period for Reply

A SHORTENED STATUTORY PERIOD FOR REPLY IS SET TO EXPIRE 3 MONTH(S) OR THIRTY (30) DAYS, WHICHEVER IS LONGER, FROM THE MAILING DATE OF THIS COMMUNICATION.

- Extensions of time may be available under the provisions of 37 CFR 1.136(a). In no event, however, may a reply be timely filed after SIX (6) MONTHS from the mailing date of this communication.
- If NO period for reply is specified above, the maximum statutory period will apply and will expire SIX (6) MONTHS from the mailing date of this communication.
- Failure to reply within the set or extended period for reply will, by statute, cause the application to become ABANDONED (35 U.S.C. § 133). Any reply received by the Office later than three months after the mailing date of this communication, even if timely filed, may reduce any earned patent term adjustment. See 37 CFR 1.704(b).

Status

- 1) ☒ Responsive to communication(s) filed on 26 March 2007.
- 2a) ☒ This action is **FINAL**. 2b) ☐ This action is non-final.
- 3) ☐ Since this application is in condition for allowance except for formal matters, prosecution as to the merits is closed in accordance with the practice under *Ex parte Quayle*, 1935 C.D. 11, 453 O.G. 213.

Disposition of Claims

- 4) ☒ Claim(s) 1-21 is/are pending in the application.
- 4a) Of the above claim(s) _____ is/are withdrawn from consideration.
- 5) ☐ Claim(s) _____ is/are allowed.
- 6) ☒ Claim(s) 1-21 is/are rejected.
- 7) ☐ Claim(s) _____ is/are objected to.
- 8) ☐ Claim(s) _____ are subject to restriction and/or election requirement.

Application Papers

- 9) ☐ The specification is objected to by the Examiner.
- 10) ☐ The drawing(s) filed on _____ is/are: a) ☐ accepted or b) ☐ objected to by the Examiner.
Applicant may not request that any objection to the drawing(s) be held in abeyance. See 37 CFR 1.85(a).
Replacement drawing sheet(s) including the correction is required if the drawing(s) is objected to. See 37 CFR 1.121(d).
- 11) ☐ The oath or declaration is objected to by the Examiner. Note the attached Office Action or form PTO-152.

Priority under 35 U.S.C. § 119

- 12) ☐ Acknowledgment is made of a claim for foreign priority under 35 U.S.C. § 119(a)-(d) or (f).
- a) ☐ All b) ☐ Some * c) ☐ None of:
1. ☐ Certified copies of the priority documents have been received.
 2. ☐ Certified copies of the priority documents have been received in Application No. _____.
 3. ☐ Copies of the certified copies of the priority documents have been received in this National Stage application from the International Bureau (PCT Rule 17.2(a)).

* See the attached detailed Office action for a list of the certified copies not received.

Attachment(s)

- | | |
|--|---|
| 1) <input checked="" type="checkbox"/> Notice of References Cited (PTO-892) | 4) <input type="checkbox"/> Interview Summary (PTO-413)
Paper No(s)/Mail Date. _____ |
| 2) <input type="checkbox"/> Notice of Draftsperson's Patent Drawing Review (PTO-948) | 5) <input type="checkbox"/> Notice of Informal Patent Application |
| 3) <input checked="" type="checkbox"/> Information Disclosure Statement(s) (PTO/SB/08)
Paper No(s)/Mail Date <u>3/22/07 & 4/27/07</u> . | 6) <input type="checkbox"/> Other: _____ |

DETAILED ACTION

Claim Rejections - 35 USC § 112

The following is a quotation of the first paragraph of 35 U.S.C. 112:

The specification shall contain a written description of the invention, and of the manner and process of making and using it, in such full, clear, concise, and exact terms as to enable any person skilled in the art to which it pertains, or with which it is most nearly connected, to make and use the same and shall set forth the best mode contemplated by the inventor of carrying out his invention.

Claims 18, 20, and 21 are rejected under 35 U.S.C. 112, first paragraph, as failing to comply with the written description requirement. The claim(s) contains subject matter which was not described in the specification in such a way as to reasonably convey to one skilled in the relevant art that the inventor(s), at the time the application was filed, had possession of the claimed invention. Claims 18 and 21 contain language including "the printed circuit board is substantially rigid" on line 2. The specification does not support this claimed limitation or even suggest that the printed circuit board is substantially rigid (as was discussed in prior office actions to the applicant). Claim 20 contains language providing that the plastic casing provides mechanical "stiffness" to the bent portion, which is not supported nor suggested by the specification in such a way as to reasonably convey to one skilled in the relevant art that the inventor(s), at the time the application was filed, had possession of the claimed invention. The examiner notes that newly added claim 17 (similar to the language of claim 20) is supported by the specification for the plastic casing providing mechanical "support," and suggests that the applicant follow this direction when amending claim 20 to maintain support from the specification.

Claim Rejections - 35 USC § 102

The following is a quotation of the appropriate paragraphs of 35 U.S.C. 102 that form the basis for the rejections under this section made in this Office action:

A person shall be entitled to a patent unless –

(e) the invention was described in (1) an application for patent, published under section 122(b), by another filed in the United States before the invention by the applicant for patent or (2) a patent granted on an application for patent by another filed in the United States before the invention by the applicant for patent, except that an international application filed under the treaty defined in section 351(a) shall have the effects for purposes of this subsection of an application filed in the United States only if the international application designated the United States and was published under Article 21(2) of such treaty in the English language.

Claims 1, 2, and 6-21 are rejected under 35 U.S.C. 102(e) as being anticipated by Ames et al. (US 2003/0085054 A1).

With respect to claim 1, Ames discloses a method of manufacturing an optical transceiver module (p. 2, [0010]), connecting a plurality of electrical contacts of a lead frame connector to corresponding leads of an optical sub-assembly to obtain a combined structure that includes the lead frame connector and the optical sub-assembly (p. 2, [0016]-[0017]); and Ames discloses attaching the optical sub-assembly to a printed circuit board using the lead frame connector such that the lead frame connector electrically connects the optical sub-assembly to the printed circuit board (p. 2, [0010] and [0018]). Ames also discloses the lead frame connector provides mechanical support for the optical sub-assembly; See figures 2 and 8-10, which show that there is no additional support for the optical assembly other than the flex cable, and see the support (66) in figure 9 (p. 3, [0023] and [0027]).

With regard to claim 2, the teachings of Ames et al. are the same as relied upon in the rejection of claim 1. Ames also discloses passing each of the leads of the optical

sub-assembly through a hole in the corresponding electrical contact, and soldering the leads to the corresponding electrical contacts (p. 2, [0016]).

Regarding claim 6, the teachings of Ames et al. are the same as relied upon in the rejection of claim 1. Ames also discloses the optical sub-assembly is a transmitter optical sub-assembly (p. 1-2, [0009]-[0010]).

With respect to claim 7, the teachings of Ames et al. are the same as relied upon in the rejection of claim 1. Ames also discloses the optical subassembly as a receiver optical sub-assembly (p. 1-2, [0009]-[0010]).

With respect to claim 8, the teachings of Ames et al. are the same as relied upon in the rejection of claim 1. Ames also discloses connecting the plurality of electrical contacts to corresponding leads includes self-alignment of the lead frame connector with respect to the optical sub-assembly as the corresponding leads pass through holes in the electrical contacts (p. 2, [0016], lines 8-14).

Regarding claim 9, Ames discloses a method of manufacturing an optical transceiver module (p. 2, [0010]), obtaining a lead frame connector (p. 2, [0012]) that includes an electrically insulating casing (p. 2, [0013]), a plurality of conductors that are electrically isolated one from another by the electrically insulating casing (p. 2, [0013]); and the plurality of conductors forming a plurality of electrical contacts that correspond to leads of the optical sub-assembly (p. 2, [0016], lines 1-3), and a plurality of leads that correspond to conductive structure on the printed circuit board (p. 2, [0018]). Ames also discloses connecting the plurality of electrical contacts of the lead frame connector to the corresponding leads of an optical sub-assembly to obtain a combined structure that

includes the lead frame connector and the optical sub-assembly (p. 2, [0016]-[0017]), and attaching the optical sub-assembly to a printed circuit board using the lead frame connector such that the lead frame connector electrically connects the optical sub-assembly to the printed circuit board (p. 2, [0010] and [0018]). Ames also discloses the lead frame connector provides mechanical support for the optical sub-assembly; See figures 2 and 8-10, which show that there is no additional support for the optical assembly other than the flex cable, and see the support (66) in figure 9 (p. 3, [0023] and [0027]).

With regard to claim 10, the teachings of Ames et al. are the same as relied upon in the rejection of claim 1. Ames also discloses attaching the optical assembly to the printed circuit board using the lead frame connector comprising a plurality of leads of the lead frame connector to corresponding conductive structures on the printed circuit board of the optical transceiver module (p. 1-2, [0009] and p. 2, [0013]-[0014]).

Regarding claim 11, the teachings of Ames et al. are the same as relied upon in the rejection of claim 1. Ames also discloses bending the plurality of electrical contacts at discrete segments of the electrical contacts (p. 2, [0016]-[0020]).

With respect to claim 12, the teachings of Ames et al. are the same as relied upon in the rejection of claims 1 and 11. Ames also discloses the electrical contact are bent at segments thereof prior to connecting the plurality of electrical contacts of the lead frame connector to corresponding leads of the optical sub-assembly (p. 2, [0019]-[0020], noting that the contacts are bent in order to fit the configuration desired for connection).

With regard to claim 13, the teachings of Ames et al. are the same as relied upon in the rejection of claims 1 and 11. Ames also discloses the electrical contacts are bent at segments thereof prior to attaching the optical sub-assembly to the printed circuit board using the lead frame connector (p. 2, [0018]-[0020]).

Regarding claim 14, the teachings of Ames et al. are the same as relied upon in the rejection of claims 1 and 11. Ames also discloses two of the segments of the bent electrical contacts are encased within a plastic (polyamide, a thermoplastic material) casing (p. 2, [0013] and see figures 1, 2, and 8-10 reference number 10).

With respect to claim 15, the teachings of Ames et al. are the same as relied upon in the rejection of claim 1. Ames also discloses a first end of each of the electrical contacts is encased in a plastic casing and a second [end] (noting that the examiner assumed the applicant meant to claim a second end of the contacts) of each of the electrical contacts is not encased and capable of being soldered to the printed circuit board (p. 2, [0017]-[0018]).

With respect to claim 16, the teachings of Ames et al. are the same as relied upon in the rejection of claim 1. Ames also discloses a bent portion of at least one of the electrical contacts is encased in a plastic casing ([0015]).

With regard to claim 17, the teachings of Ames et al. are the same as relied upon in the rejection of claims 1 and 16. Ames also discloses the plastic casing provides mechanical support to the bent portion of the at least one of the electrical contacts encased within the plastic casing; where Ames discloses the mechanical support to the conductors is provided so that the conductors don't short via contact with one another,

and to form the flex cable which is bent preferably to 90 degrees ([0012]-[0015] and [0019]).

Regarding claim 18, the teachings of Ames et al. are the same as relied upon in the rejection of claim 1. And although there is no support for a rigid lead frame connector within Applicant's specification; Ames discloses a portion of the lead frame connector between the optical subassembly and the printed circuit board is bent for advantages in connection; therefore suggesting that the bend is not removed or changed while the connection between electrical units is maintained ([0019]-[0020]).

With respect to claim 19, the teachings of Ames et al. are the same as relied upon in the rejection of claims 1 and 11. Ames also discloses a bent portion of at least one of the electrical contacts is encased in a plastic casing ([0015]).

With regard to claim 20, the teachings of Ames et al. are the same as relied upon in the rejection of claims 1, 11, and 19. Ames also although there is no support for the plastic casing providing mechanical stiffness to the bent portion of the contacts; Ames discloses the plastic casing provides mechanical support to the bent portion of the at least one of the electrical contacts encased within the plastic casing; where Ames discloses the mechanical support to the conductors is provided so that the conductors don't short via contact with one another; and to form the flex cable which is bent preferably to 90 degrees ([0012]-[0015] and [0019]).

Regarding claim 21, the teachings of Ames et al. are the same as relied upon in the rejection of claims 1 and 11. And although there is no support for a rigid lead frame connector within Applicant's specification; Ames discloses a portion of the lead frame

connector between the optical subassembly and the printed circuit board is bent for advantages in connection; therefore suggesting that the bend is not removed or changed while the connection between electrical units is maintained ([0019]-[0020]).

Claim Rejections - 35 USC § 103

The following is a quotation of 35 U.S.C. 103(a) which forms the basis for all obviousness rejections set forth in this Office action:

(a) A patent may not be obtained though the invention is not identically disclosed or described as set forth in section 102 of this title, if the differences between the subject matter sought to be patented and the prior art are such that the subject matter as a whole would have been obvious at the time the invention was made to a person having ordinary skill in the art to which said subject matter pertains. Patentability shall not be negated by the manner in which the invention was made.

Claims 1-4 and 6-15 are rejected under 35 U.S.C. 103(a) as being unpatentable over Card et al. (US 5,295,214) in view of Ames et al. (US 2003/0085054 A1).

Card discloses a "process for manufacturing the improved soldered joint between an optical sub-assembly and a flexible ribbon cable; and more generally between the leads of a component and an electrical interconnect structure," (Card et al., col. 3, lines 54-58) as seen in figure 1(100). Card also discloses there is a connection between the exposed terminals of the conductors on the optical sub-assembly and the electrical circuit (col. 4, lines 64-68). Furthermore, Card discloses mass soldering of any flexible or rigid circuit board (abstract) and states, "the soldering bridge is made an integral part of the land so that the soldering bridge contributes to the strength of the connection between the land and the solder joint" (col. 6, lines 31-34). Card discloses that the leads in figure 1(104) are soldered within the holes in figure 1(106) (col. 4, lines 55-57 and col. 9, lines 63-69). Card's disclosure of figure 1 and the positioning of "an

electrical interconnection member within said housing and adjacent said first and second optical sub-assembly on the side of the sub-assemblies from which the leads extend, for electrical interconnection between elements of said optical module" (col. 10, lines 31-36). Card discloses the method in which the optical sub-assembly and the ribbon cable are positioned, and lists reflow soldering as a process to attain this configuration (col. 8, lines 14-21). Card also disclosed "typically, one optical sub-assembly is a light transmitter for converting an electrical signal into an optical signal and the other is a light receiver for converting the optical signal into an electrical signal" (col. 1, lines 48-53). Column 5, lines 24-29 refers to a transmitter optical sub-assembly and column 4, lines 51-57 refer to a receiver optical sub-assembly. Card's discloses leads that are "integrally connected" to conductors that extend into a dielectric layer of the flexible cables (col. 4, lines 57-60). Card teaches a dielectric layer with which the leads are connected to and conductors extend from (col. 4, lines 57-60), as seen in figure 1. The general definition of a dielectric material is one that is non-conducting and is therefore considered insulating. Card discloses a "process for manufacturing the improved soldered joint between an optical sub-assembly and a flexible ribbon cable; and more generally between the leads of a component and an electrical interconnect structure," (col. 3, lines 54-58) as seen in figure 1(100). Card also discloses electrical contacts corresponding to the leads of the optical sub-assembly and conductors connected to a circuit (col. 3, lines 54-58 and col. 4, lines 64-68). Furthermore, Card discloses mass soldering of any flexible or rigid circuit board (abstract) and states, "the soldering bridge is made an integral part of the land so that the soldering bridge

contributes to the strength of the connection between the land and the solder joint" (col. 6, lines 31-34). Card also discloses bending the plurality of electrical contacts at discrete segments of the electrical contacts (col. 4, lines 64-69), two of the segments of the bent electrical contacts are encased with a plastic casing (polyamide, a thermoplastic material) (col. 7, lines 64-68 and figures 1-2(10)), and a first end of each of the electrical contacts is encased in a plastic casing and a second (end) of each of the each of the electrical contacts is not encased and capable of being soldered to the printed circuit board (col. 4, lines 55-68 and col. 7, lines 64-68). However, Card lacks suggestion that the lead frame connector (flexible cable) provides mechanical support for the optical sub-assembly. Ames discloses a lead frame connector provides mechanical support for the optical sub-assembly; See figures 2 and 8-10, which show that there is no additional support for the optical assembly other than the flex cable, and see the support (66) in figure 9 (Ames et al., p. 3, [0023] and [0027]). Ames also discloses bending the plurality of electrical contacts at discrete segments of the electrical contacts (p. 2, [0016]-[0020]), and the electrical contacts are bent at segments thereof prior to attaching the optical sub-assembly to the printed circuit board using the lead frame connector (p. 2, [0018]-[0020]). Ames discloses a bent portion of at least one of the electrical contacts is encased in a plastic casing ([0015]). Furthermore, Ames discloses the plastic casing provides mechanical support to the bent portion of the at least one of the electrical contacts encased within the plastic casing; where Ames discloses the mechanical support to the conductors is provided so that the conductors don't short via contact with one another, and to form the flex cable which is bent

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preferably to 90 degrees ([0012]-[0015] and [0019]). Although there is no support for a rigid lead frame connector within Applicant's specification; Ames discloses a portion of the lead frame connector between the optical subassembly and the printed circuit board is bent for advantages in connection; therefore suggesting that the bend is not removed or changed while the connection between electrical units is maintained ([0019]-[0020]). Thus, it would have been obvious to one of ordinary skill in the art at the time of the invention to modify the invention of Card et al. to include the lead frame mechanical support of Ames et al. in order to prevent stress in the flex cable, and in the respective electrical connections between the leads and the flex cable (Ames et al., p. 3, [0023], lines 12-14).

Claim 4 is rejected under 35 U.S.C. 103(a) as being unpatentable over Ames et al. (US 2003/0085054 A1) as applied to claim 10 above, and further in view of Card et al. (US 5,295,214).

The teachings of Ames et al. are the same as relied upon in the rejection of claims 1 and 10. However, Ames lacks specific disclosure of reflow soldering the leads to the conductive structures. Card discloses the method in which the optical subassembly and the ribbon cable are positioned, and lists reflow soldering as a process to attain this configuration (Card et al., col. 8, lines 14-21). Therefore, it would have been obvious to one of ordinary skill in the art at the time of the invention to modify the invention of Ames et al. to include the reflow soldering method of Card et al. in order to

connect the sub-assembly to the cable (Card et al., col. 8, lines 10-20) and form an improved solder joint (Card et al., col. 3, lines 35-46).

Claim 5 is rejected under 35 U.S.C. 103(a) as being unpatentable over Ames et al. (US 2003/0085054 A1) as applied to claim 10 above, and further in view of Liu et al. (US 2003/0026081).

The teachings of Ames et al. are the same as relied upon in the rejection of claims 1 and 10. However, Ames does not disclose the hot bar process as the method for connecting the leads of the conductive structure to the printed circuit board. Liu teaches that the "protruding contact leads are suitable for hot bar reflow, which is where a heated bar is used to melt the contact leads such that they bond with an external surface" (Liu, p. 3, col. 2, [0028], lines 10-13), as seen in figure 1 of Liu's application. It would have been obvious to one of ordinary skill in the art at the time of the invention to modify the invention Ames et al. to utilize a hot bar process in order to provide an efficient method for connecting the leads of the conductive structure to a printed circuit board (see Liu, p. 3, [0028], lines 10-13).

Claim 5 is rejected under 35 U.S.C. 103(a) as being unpatentable over Card et al. (US 5,295,214) and Ames et al. (US 2003/0085054 A1) as applied to claim 1 above, and further in view of Liu et al. (US 2003/0026081).

The teachings of Ames et al. are the same as relied upon in the rejection of claims 1 and 10. However, the combined invention of Card and Ames does not disclose

the hot bar process as the method for connecting the leads of the conductive structure to the printed circuit board. Liu teaches that the "protruding contact leads are suitable for hot bar reflow, which is where a heated bar is used to melt the contact leads such that they bond with an external surface" (Liu, p. 3, col. 2, [0028], lines 10-13), as seen in figure 1 of Liu's application. It would have been obvious to one of ordinary skill in the art at the time of the invention to modify the combined invention of Card et al. and Ames et al. to utilize a hot bar process in order to provide an efficient method for connecting the leads of the conductive structure to a printed circuit board (see Liu, p. 3, [0028], lines 10-13).

Response to Arguments

Applicant's arguments filed March 26, 2007 have been fully considered but they are not persuasive.

Applicant first argues that Ames does not teach each and every element of the rejected claims (page 7). The examiner disagrees and points the applicant to review the rejection above, which address every claim limitation and its teaching or suggestion within Ames.

Applicant also argues that the characterization of Ames demonstrated by the examiner with regard to the flex cable being a mechanical support for the optical subassemblies is in direct contrast to the teachings of Ames which emphasizes throughout that the flex cable is intended only to "electrically couple" the ROSA and

TOSA to the transceiver wiring board. The applicant also states that there is no teaching or suggestion in Ames that the flex cable is used to mechanically support the optical subassemblies as is claimed (page 8). During patent examination, the pending claims must be "given the broadest reasonable interpretation." Applicant always has the opportunity to amend the claims during prosecution, and broad interpretation by the examiner reduces the possibility that the claim, once issued, will be interpreted more broadly than is justified. In re Prater, 415 F.2d 1393, 1404-05, 162 USPQ 541, 550-51 (CCPA 1969). The examiner notes that "support" can be interpreted in many ways for various forms and definitions of the word. As claimed, "support" is a noun which has many different definitions, as evidenced in the dictionary.com reference provided with this action. The examiner first points the applicant to definition 15 in order to understand the examiner's interpretation of the instant claim language. The flex cable of Ames clearly "mechanically supports" the optical subassemblies as that it is "aiding" the secure mechanical and electrical connection between the wiring board to the subassemblies (see definition 15 of dictionary.com "support" and the cited portions of Ames above). If looking at the definition of "support" from the applicant's arguments, it seems as though definition 12 more clearly supports the applicant's suggestions of "mechanical support" (see definition 12 of dictionary.com "support"). However, because there are multiple "correct" interpretations/definitions of the broad limitation claiming "support" to one of ordinary skill in the art, the examiner maintains her position with respect to the teachings of the prior art of record, as that they teach or suggest all of the instant broadly claimed limitations including "mechanical support." Applicant has not

distinguished the claim language from the teachings of the prior art with regard to the broadest reasonable interpretation to one of ordinary skill in the art of the instant claim language.

With regard to the 103(a) rejections, the applicant argues that the examiner has not provided a reasonable teaching or suggestion that the claimed combination of references has a reasonable expectation of success via the *Graham v. John Deere Co* (page 9). The examiner disagrees and notes that the examiner's burden has been met via the motivation to combine references which teach all of the claimed limitations provided in the rejection above and in the previous office correspondence. In response to applicant's argument that there is no suggestion to combine the references, the examiner recognizes that obviousness can only be established by combining or modifying the teachings of the prior art to produce the claimed invention where there is some teaching, suggestion, or motivation to do so found either in the references themselves or in the knowledge generally available to one of ordinary skill in the art. See *In re Fine*, 837 F.2d 1071, 5 USPQ2d 1596 (Fed. Cir. 1988) and *In re Jones*, 958 F.2d 347, 21 USPQ2d 1941 (Fed. Cir. 1992). In this case (for example with regard to the rejection of claim 1 over Card et al. in view of Ames et al.), it would have been obvious to one of ordinary skill in the art at the time of the invention to modify the invention of Card et al. to include the lead frame mechanical support of Ames et al. in order to prevent stress in the flex cable, and in the respective electrical connections between the leads and the flex cable (Ames et al., p. 3, [0023], lines 12-14).

Applicant then argues that Ames does not teach a lead frame connector which provides mechanical support for an optical sub-assembly, with regard to the obviousness rejections set forth (page 9). The examiner disagrees and points the applicant to review the teachings of Ames et al. above and the previous response to this argument regarding the 102(e) rejection of the claims over Ames et al. Furthermore, the examiner once again reminds the applicant that, during patent examination, the pending claims must be "given the broadest reasonable interpretation." Applicant always has the opportunity to amend the claims during prosecution, and broad interpretation by the examiner reduces the possibility that the claim, once issued, will be interpreted more broadly than is justified. In re Prater, 415 F.2d 1393, 1404-05, 162 USPQ 541, 550-51 (CCPA 1969).

The applicant also argues that obviousness cannot be established when one of the references teaches away from the path taken by the applicant (page 10). The examiner first disagrees that any of the references cited on the record teach away from the instant invention. However, even if the references do teach away from the instant invention, the MPEP states, "patents are relevant as prior art for all they contain," more specifically stating,

"The use of patents as references is not limited to what the patentees describe as their own inventions or to the problems with which they are concerned. They are part of the literature of the art, relevant for all they contain." *In re Heck*, 699 F.2d 1331, 1332-33, 216 USPQ 1038, 1039 (Fed. Cir. 1983) (quoting *In re Lemelson*, 397 F.2d 1006, 1009, 158 USPQ 275, 277 (CCPA 1968)).

A reference may be relied upon for all that it would have reasonably suggested to one having ordinary skill in the art, including nonpreferred embodiments. *Merck & Co. v. Biocraft Laboratories*, 874 F.2d 804, 10 USPQ2d 1843 (Fed. Cir.), cert. denied, 493 U.S. 975 (1989). See also *Celeritas Technologies Ltd. v. Rockwell*

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International Corp., 150 F.3d 1354, 1361, 47 USPQ2d 1516, 1522-23 (Fed. Cir. 1998) (The court held that the prior art anticipated the claims even though it taught away from the claimed invention. "The fact that a modem with a single carrier data signal is shown to be less than optimal does not vitiate the fact that it is disclosed.") MPEP 2123 I.

Furthermore, the examiner maintains that the test for achieving suggestion within multiple references for combination is similar to that used for achieving analogous art to that of the instant invention. More specifically, the references for combination in an obviousness rejection must be within the same field of endeavor, or, if not, then the references must be reasonably pertinent to the particular problem with which each reference is concerned. In this case, both Card et al. and Ames et al. are within the same field of endeavor, where both references are concerned with flex cables for electrically connecting electrical components to wiring boards (in particular, optical subassemblies or optical transceivers to an optical module or transceiver wiring board). See Card et al., abstract and see Ames et al., paragraphs [0009]-[0010]. Hence there is sufficient suggestion for combining the references on this aspect alone.

Conclusion

Applicant's amendment necessitated the new ground(s) of rejection presented in this Office action. Accordingly, **THIS ACTION IS MADE FINAL**. See MPEP § 706.07(a). Applicant is reminded of the extension of time policy as set forth in 37 CFR 1.136(a).

A shortened statutory period for reply to this final action is set to expire **THREE MONTHS** from the mailing date of this action. In the event a first reply is filed within

TWO MONTHS of the mailing date of this final action and the advisory action is not mailed until after the end of the THREE-MONTH shortened statutory period, then the shortened statutory period will expire on the date the advisory action is mailed, and any extension fee pursuant to 37 CFR 1.136(a) will be calculated from the mailing date of the advisory action. In no event, however, will the statutory period for reply expire later than SIX MONTHS from the date of this final action.

Any inquiry concerning this communication or earlier communications from the examiner should be directed to Rachel E. Beveridge whose telephone number is 571-272-5169. The examiner can normally be reached on Monday through Friday, 9 am to 6 pm.

If attempts to reach the examiner by telephone are unsuccessful, the examiner's supervisor, Jonathan Johnson can be reached on 571-272-1177. The fax phone number for the organization where this application or proceeding is assigned is 571-273-8300.

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Information regarding the status of an application may be obtained from the Patent Application Information Retrieval (PAIR) system. Status information for published applications may be obtained from either Private PAIR or Public PAIR. Status information for unpublished applications is available through Private PAIR only. For more information about the PAIR system, see <http://pair-direct.uspto.gov>. Should you have questions on access to the Private PAIR system, contact the Electronic Business Center (EBC) at 866-217-9197 (toll-free). If you would like assistance from a USPTO Customer Service Representative or access to the automated information system, call 800-786-9199 (IN USA OR CANADA) or 571-272-1000.

/reb/

June 13, 2007



**JONATHAN JOHNSON
PRIMARY EXAMINER**